## SCANSWITCHTM

NPN Bipolar Power Deflection Transistors For High and Very High Resolution CRT Monitors

The MJF16206 and the MJW16206 are state-of-the-art SWITCHMODE bipolar power transistors. They are specifically designed for use in horizontal deflection circuits for high and very high resolution, monochrome and color CRT monitors.

- 1200 Volt VCES Breakdown Capability
- Typical Dynamic Desaturation Specified (New Turn-Off Characteristic)
- Maximum Repetitive Emitter-Base Avalanche Energy Specified (Industry First)
- High Current Capability: Performance Specified at 6.5 Amps Continuous Rating - 12 Amps Max Pulsed Rating - 15 Amps Max
- Isolated MJF16206 is UL Recognized
- Fast Switching: 100 ns Inductive Fall Time (Typ)

1000 ns Inductive Storage Time (Typ)

- Low Saturation Voltage
0.25 Volts (Typ) at 6.5 Amps Collector Current
- High Emitter-Base Breakdown Capability For High Voltage Off Drive Circuits 8.0 V (Min)


## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-Emitter Breakdown Voltage | $\mathrm{V}_{\text {CES }}$ | 1200 | Vdc |
| Collector-Emitter Sustaining Voltage | $\mathrm{V}_{\text {CEO }}$ (sus) | 500 | Vdc |
| Emitter-Base Voltage | VEBO | 8.0 | Vdc |
| Isolation Voltage <br> (RMS for $1 \mathrm{sec} ., \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, <br> Figure 19 <br> Relative Humidity $\leq 30 \%$ ) <br> Figure 20 | VISOL | - | $\mathrm{V}_{\mathrm{rms}}$ |
| Collector Current - Continuous <br> - Pulsed (1) | $\begin{aligned} & \hline \mathrm{IC} \\ & \mathrm{ICM} \end{aligned}$ | $\begin{aligned} & 12 \\ & 15 \end{aligned}$ | Adc |
| Base Current - Continuous <br> - Pulsed (1) | $\begin{aligned} & \hline \text { IB } \\ & \text { IBM } \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 10 \end{aligned}$ | Adc |
| Repetitive Emitter-Base Avalanche Energy | $\mathrm{W}_{\text {(BER) }}$ | 0.2 | mjoules |
| Total Power Dissipation @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ <br> Derated above $25^{\circ} \mathrm{C}$ | PD | $\begin{gathered} \hline 150 \\ 39 \\ 1.49 \end{gathered}$ | Watts <br> W/ ${ }^{\circ} \mathrm{C}$ |
| Operating and Storage Temperature | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

## THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance - Junction to Case | $\mathrm{R}_{\text {日JC }}$ | 0.67 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead Temperature for Soldering Purposes $1 / 8^{\prime \prime}$ <br> from the Case for 5 seconds | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

(1) Pulse Test: Pulse Width $=5.0 \mathrm{~ms}$, Duty Cycle $\leq 10 \%$.

SCANSWITCH is a trademark of Motorola Inc.

ELECTRICAL CHARACTERISTICS $\left(T_{C}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (1) |  |  |  |  |  |
| $\begin{aligned} & \text { Collector Cutoff Current } \\ & \left(\mathrm{V}_{\mathrm{CE}}=1200 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{BE}}=0 \mathrm{~V}\right) \\ & \left(\mathrm{V}_{\mathrm{CE}}=850 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{BE}}=0 \mathrm{~V}\right) \end{aligned}$ | ICES | - | - | $\begin{gathered} 250 \\ 25 \end{gathered}$ | $\mu \mathrm{Adc}$ |
| Emitter-Base Leakage $\left(\mathrm{V}_{\mathrm{EB}}=8.0 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=0\right)$ | IEBO | - | - | 25 | $\mu \mathrm{Adc}$ |
| Collector-Emitter Sustaining Voltage (Figure 10) $\left(\mathrm{I}_{\mathrm{C}}=10 \mathrm{mAdc}, \mathrm{I}_{\mathrm{B}}=0\right)$ | $\mathrm{V}_{\text {CEO }}$ (sus) | 500 | - | - | Vdc |
| Emitter-Base Breakdown Voltage $(\mathrm{I} \mathrm{E}=1.0 \mathrm{~mA}, \mathrm{I} \mathrm{C}=0)$ | $\mathrm{V}_{(\mathrm{BR}) \mathrm{EBO}}$ | 8.0 | 11 | - | Vdc |

## ON CHARACTERISTICS (1)

| Collector-Emitter Saturation Voltage $\begin{aligned} & \left(\mathrm{I} \mathrm{C}=3.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=400 \mathrm{mAdc}\right) \\ & \left(\mathrm{I} \mathrm{C}=6.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.5 \mathrm{Adc}\right) \end{aligned}$ | $\mathrm{V}_{\text {CE }}$ (sat) | - | $\begin{aligned} & 0.15 \\ & 0.25 \end{aligned}$ | 1.0 1.0 | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Base-Emitter Saturation Voltage ( $\mathrm{IC}=6.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.5 \mathrm{Adc}$ ) | $\mathrm{V}_{\mathrm{BE}}$ (sat) | - | 0.9 | 1.5 | Vdc |
| $\begin{aligned} & \text { DC Current Gain } \\ & \text { (IC } \left.=1.0 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}\right) \\ & \left(\mathrm{IC}_{\mathrm{C}}=10 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}\right) \\ & \left(\mathrm{IC}=12 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}\right) \end{aligned}$ | $h_{\text {FE }}$ | 5.0 3.0 | $\begin{aligned} & 24 \\ & 8.0 \\ & 6.0 \end{aligned}$ | 13 | - |

## DYNAMIC CHARACTERISTICS

| Dynamic Desaturation Interval (Figure 15) ( $\mathrm{I}_{\mathrm{C}}=6.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.5 \mathrm{Adc}, \mathrm{L}_{\mathrm{B}}=0.5 \mu \mathrm{H}$ ) | ${ }^{\text {d }}$ ds | - | 250 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Emitter-Base Avalanche Turn-off Energy (Figure 15) $\left(\mathrm{t}=500 \mathrm{~ns}, \mathrm{R}_{\mathrm{BE}}=22 \Omega\right)$ | ${ }^{\text {EB }}$ (off) | - | 30 | - | $\mu \mathrm{joules}$ |
| Output Capacitance $\left(\mathrm{V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{E}}=0, \mathrm{f}_{\mathrm{test}}=100 \mathrm{kHz}\right)$ | $\mathrm{C}_{\text {ob }}$ | - | 180 | 350 | pF |
| Gain Bandwidth Product $\left(\mathrm{V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=0.5 \mathrm{~A}, \mathrm{f}_{\mathrm{test}}=1.0 \mathrm{MHz}\right)$ | ${ }^{\text {T }}$ | - | 3.0 | - | MHz |
| Collector-Heatsink Capacitance - MJF16206 Isolated Package (Mounted on a $1^{\prime \prime} \times 2^{\prime \prime} \times 1 / 16^{\prime \prime}$ Copper Heatsink, $\left.\mathrm{V}_{\mathrm{CE}}=0, \mathrm{f}_{\mathrm{test}}=100 \mathrm{kHz}\right)$ | $\mathrm{C}_{\mathrm{c}-\mathrm{hs}}$ | - | 17 | - | pF |

## SWITCHING CHARACTERISTICS


(1) Pulse Test: Pulse Width $=300 \mu \mathrm{~s}$, Duty Cycle $\leq 2.0 \%$.


Figure 1. Typical DC Current Gain


Figure 3. Typical Collector Saturation Region


Figure 5. Typical Capacitance


Figure 2. Typical Collector-Emitter Saturation Voltage


Figure 4. Typical Base-Emitter Saturation Voltage


Figure 6. Typical Transition Frequency


Figure 7. Maximum Forward Biased Safe Operating Area

## FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate IC - VCE limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 7 is based on $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} ; \mathrm{T}_{\mathrm{J}}(\mathrm{pk})$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to $10 \%$ but must be derated when $\mathrm{T}_{\mathrm{C}} \geq 25^{\circ} \mathrm{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 7 may be found at any case temperature by using the appropriate curve on Figure 9.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

## REVERSE BIAS

Inductive loads, in most cases, require the emitter-tobase junction be reversed biased because high voltage and high current must be sustained simultaneously during turnoff. Under these conditions, the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as


Figure 8. Maximum Reverse Bias Safe Operating Area


Figure 9. Power Derating
active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Biased Safe Operating Area and represents the voltage-current condition allowable during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 8 gives the RBSOA characteristics.


Note: Adjust - V to obtain desired $\mathrm{V}_{\mathrm{BE}}$ (off) at Point A .
Figure 10. RBSOA/V(BR)CEO(sus) Test Circuit


Figure 11. Thermal Response


Figure 12. Switching Safe Operating Area

## DYNAMIC DESATURATION

The SCANSWITCH series of bipolar power transistors are specifically designed to meet the unique requirements of horizontal deflection circuits in computer monitor applications. Historically, deflection transistor design was focused on minimizing collector current fall time. While fall time is a valid figure of merit, a more important indicator of circuit performance as scan rates are increased is a new characteristic, "dynamic desaturation." In order to assure a linear collector current ramp, the output transistor must remain in hard saturation during storage time and exhibit a rapid turn-off transition. A sluggish transition results in serious consequences.


Figure 13. Deflection Simulator Switching Waveforms From Circuit in Figure 15

As the saturation voltage of the output transistor increases, the voltage across the yoke drops. Roll off in the collector current ramp results in improper beam deflection and distortion of the image at the right edge of the screen. Design changes have been made in the structure of the SCANSWITCH series of devices which minimize the dynamic desaturation interval. Dynamic desaturation has been defined in terms of the time required for the $\mathrm{V}_{\mathrm{CE}}$ to rise from 1.0 to 5.0 volts (Figures 13 and 14) and typical performance at optimized drive conditions has been specified. Optimization of device structure results in a linear collector Current ramp, excellent turn-off switching performance, and significantly lower overall power dissipation.


Figure 14. Definition of Dynamic Desaturation Measurement

## EMITTER-BASE TURN-OFF ENERGY

Typical techniques for driving horizontal outputs rely on a pulse transformer to supply forward base current, and a turn-off network that includes a series base inductor to limit the rate of transition from forward to reverse drive. An alternate drive scheme has been used to characterize the SCANSWITCH series of devices (see Figure 15). This circuit produces a ramp of base drive, eliminating the heavy overdrive at the beginning of the collector current ramp and underdrive just prior to turnoff produced by typical drive strategies. This high performance drive has two additional impor-
tant advantages. First, the configuration of $T_{1}$ allows $L_{B}$ to be placed outside the path of forward base current making it unnecessary to expend energy to reverse current flow as in a series base inductor. Second, there is no base resistor to limit forward base current and hence no power loss associated with setting the value of the forward base current. The process of generating the ramp stores rather than dissipates energy. Tailoring the amount of energy stored in $\mathrm{T}_{1}$ to the amount of energy, $\mathrm{EB}_{\text {(off) }}$, that is required to turn-off the output transistor results in essentially lossless operation. [Note: $B+$ and the primary inductance of $T_{1}\left(L_{p}\right)$ are chosen such that $\left.1 / 2 L_{p} \mathrm{l}_{\mathrm{b}}{ }^{2}=E B_{(o f f)}\right)$.


Figure 15. High Resolution Deflection Application Simulator


Figure 16. Resistive Load Switching


Figure 17. Typical Resistive Storage Time


Figure 18. Typical Resistive Fall Time

## TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**


Figure 21. Typical Mounting Techniques*
Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in • Ibs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of $20 \mathrm{in} \cdot$ Ibs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in - lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in • lbs of mounting torque under any mounting conditions.
** For more information about mounting power semiconductors see Application Note AN1040.


| $母$ | $0.25(0.010)$ |
| :--- | :--- | :--- | :--- |



1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 19.7 | 20.3 | 0.776 | 0.799 |
| B | 15.3 | 15.9 | 0.602 | 0.626 |
| C | 4.7 | 5.3 | 0.185 | 0.209 |
| D | 1.0 | 1.4 | 0.039 | 0.055 |
| E | 1.27 REF |  | 0.050 REF |  |
| F | 2.0 | 2.4 | 0.079 | 0.094 |
| G | 5.5 BSC |  | 0.216 BSC |  |
| H | 2.2 | 2.6 | 0.087 | 0.102 |
| J | 0.4 | 0.8 | 0.016 | 0.031 |
| K | 14.2 | 14.8 | 0.559 | 0.583 |
| L | 5.5 NOM |  | 0.217 NOM |  |
| P | 3.7 | 4.3 | 0.146 | 0.169 |
| Q | 3.55 | 3.65 | 0.140 | 0.144 |
| R | 5.0 NOM |  | 0.197 NOM |  |
| U | 5.5 BSC |  | 0.217 BSC |  |
| V | 3.0 | 3.4 | 0.118 | 0.134 |

CASE 340K-01
TO-247AE ISSUE 0

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and (M) are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

## How to reach us:

USA/EUROPE/Locations Not Listed: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447 or 602-303-5454

MFAX: RMFAX0@email.sps.mot.com - TOUCHTONE 602-244-6609 INTERNET: http://Design-NET.com

JAPAN: Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, 6F Seibu-Butsuryu-Center, 3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-81-3521-8315

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

